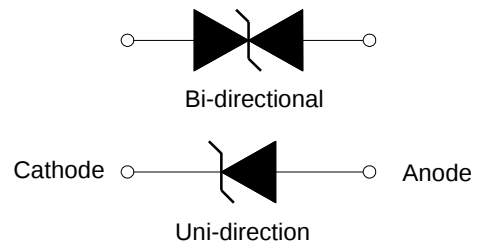


Features

- ◆ Excellent capability of absorbing transient surge
- ◆ Quick response to surge voltage (ns Level)
- ◆ Eliminates over voltage caused by fast rising transients
- ◆ Moisture sensitivity level: Level 1
- ◆ Weight 69 mg (approximate)
- ◆ Non degenerative
- ◆ Response Time is < 1us
- ◆ ROHS compliant

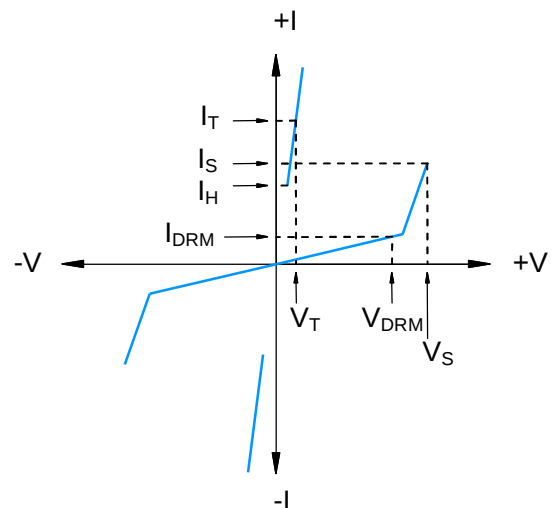
Applicable Global Standards

- ◆ TIA-968-A
- ◆ ITU K.20/21 Enhanced level
- ◆ ITU K.20/21 Basic Level
- ◆ GR 1089 Inter building
- ◆ GR 1089 Inter building
- ◆ IEC 6100-4-5
- ◆ YD/T 1082



Electrical Parameters

Parameter	Definition
I_S	Switching Current - maximum current required to switch to on state
I_{DRM}	Leakage Current - maximum peak off-state current measured at V_{DRM}
I_H	Holding Current - minimum current required to maintain on state
I_T	On-state Current - maximum rated continuous on-state current
V_S	Switching Voltage - maximum voltage prior to switching to on stat
V_{DRM}	Peak Off-state Voltage - maximum voltage that can be applied while maintaining off state
V_T	On-state Voltage - maximum voltage measured at rated on-state current
C_0	Off-state Capacitance - typical capacitance measured in off state



Electrical Characteristics

Part Number	Marking	V_{DRM} @ $I_{DRM}=5\mu A$	I_{DRM}	V_S @100V/ μS	I_S	V_T @ $I_T=2.2A$	I_T	I_H	C_o @1MHz
		V min	μA max	V max	mA max	V max	A max	mA min	pF max
P0080TB	P008B	6	5	25	800	4	2.2	50	50
P0300TB	P03B	25	5	40	800	4	2.2	50	70
P0640TB	P06B	58	5	77	800	4	2.2	150	50
P0720TB	P07B	65	5	88	800	4	2.2	150	50
P0900TB	P09B	75	5	98	800	4	2.2	150	45
P1100TB	P11B	90	5	130	800	4	2.2	150	45
P1300TB	P13B	120	5	160	800	4	2.2	150	45
P1500TB	P15B	140	5	180	800	4	2.2	150	40
P1800TB	P18B	170	5	220	800	4	2.2	150	40
P2000TB	P20B	180	5	220	800	4	2.2	150	40
P2300TB	P23B	190	5	260	800	4	2.2	150	35
P2600TB	P26B	220	5	300	800	4	2.2	150	35
P3100TB	P31B	275	5	350	800	4	2.2	150	30
P3500TB	P35B	320	5	400	800	4	2.2	150	30
P3800TB	P38B	360	5	460	800	4	2.2	150	30
P4200TB	P42B	400	5	520	800	4	2.2	150	30
P4500TB	P45B	420	5	540	800	4	2.2	150	30
P5000TB	P50B	440	5	600	800	4	2.2	150	30

Notes:

- Absolute maximum ratings measured at $T_A=25^\circ C$ (unless otherwise noted).
- Devices are bi-directional.

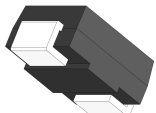
Surge Ratings

Series	2/10 S^1	8/20 S^1	10/160 S^1	10/560 S^1	10/1000 S^1	5/310 S^1	I_{TSM} 50/60 Hz	di/dt
	2/10 S^2	1.2/50 S^2	10/160 S^2	10/560 S^2	10/1000 S^2	10/700 S^2		
	A min	A min	A min	A min	A min	A min	A min	Amps/ μs max
B	250	250	250	200	80	100	30	500

Notes:

- Current waveform in μs
 - Voltage waveform in μs
- Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product.
 - I_{PP} ratings applicable over temperature range of $-40^\circ C$ to $+85^\circ C$
 - The device must initially be in thermal equilibrium with $-40^\circ C < T_J < +150^\circ C$

Thermal Considerations

Package	Symbol	Parameter	Value	Unit
DO-214AC 	T_J	Operating Junction Temperature Range	- 40 to + 125	$^\circ C$
	T_S	Storage Temperature Range	- 60 to +150	$^\circ C$
	R_{JA}	Thermal Resistance: Junction to Ambient	90	$^\circ C/W$

Characteristic Curves

Figure 1 - V-I Characteristics

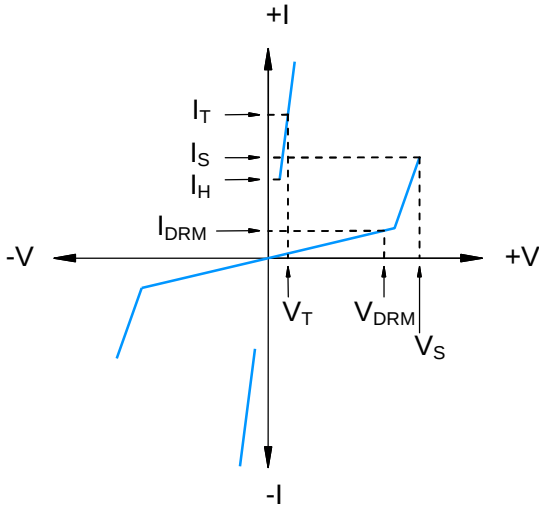


Figure 2 - $t_r \times t_d$ Pulse Waveform

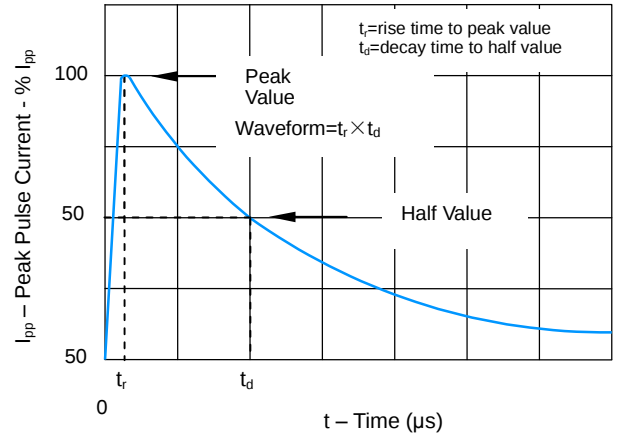


Figure 3 - Normalized V_S Change Versus Junction Temperature

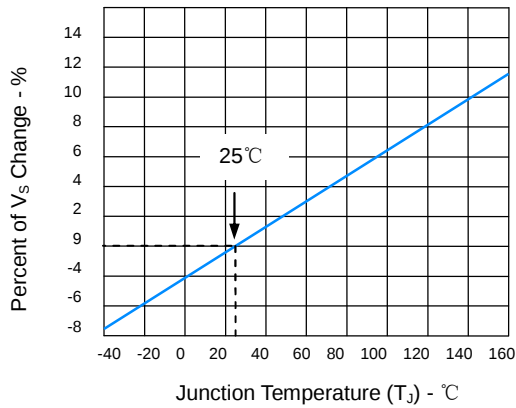
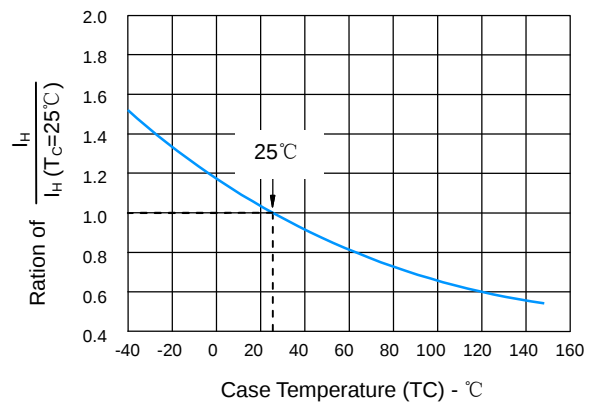


Figure 4 - Normalized DC Holding Current Versus Case Temperature



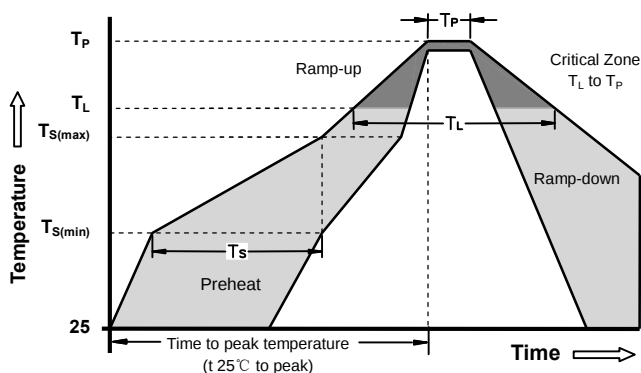
Environmental Specifications

High Temp Voltage Blocking	80% Rated VDRM (VAC Peak) +125°C or +150°C, Lead Material Copper Alloy High Temp Voltage Blocking 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 VDC (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, Thermal Shock 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/Cooker Test) JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles Level (+260°C Peak). JEDEC-J-STD-020, Level 1

Physical Specifications

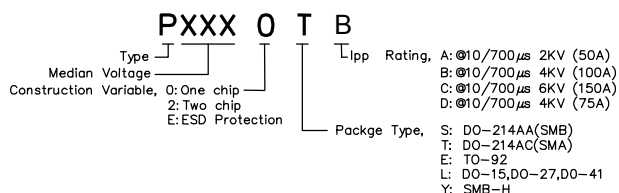
Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0

Soldering Parameters

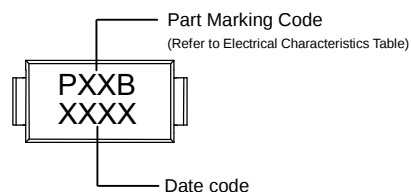


Reflow Condition		Lead -free assembly
Pre Heat	-Temperature Min ($T_{S(min)}$)	+150°C
	-Temperature Max ($T_{S(max)}$)	+200°C
	-Time (min to max) (t_s)	60 -180 Seconds
Average ramp up rate (Liquidus Temp T_L) to peak		3°C/Second Max
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/Second Max
Reflow	- Temperature (T_L) (Liquidus)	+217°C
	- Time (min to max) (t_s)	60 -150 Seconds
Peak Temperature (T_P)		260 +0/-5°C
Time within 5°C of actual peak Temperature (t_p)		8-15 Seconds Max
Ramp-down Rate		6°C/Second Max
Time 25°C to peak Temperature (T_P)		8 minutes Max
Do not exceed		+260°C

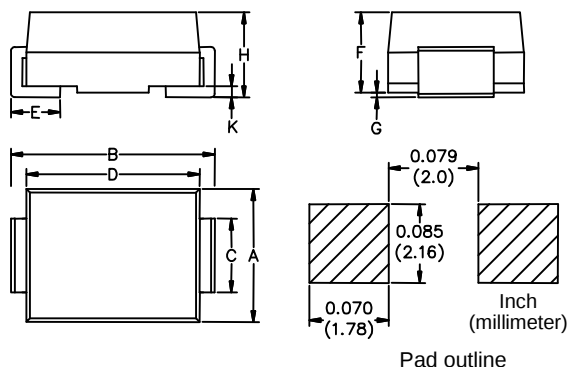
Part Numbering



Part Marking



Dimensions DO-214AA



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.100	0.110	2.54	2.79
B	0.194	0.208	4.93	5.28
C	0.049	0.065	1.25	1.65
D	0.157	0.177	3.99	4.50
E	0.030	0.060	0.76	1.52
F	0.076	0.096	1.90	2.45
G	0.002	0.008	0.05	0.20
H	0.078	0.090	1.98	2.29
K	0.006	0.012	0.15	0.30

Packaging

Part Number	Component Package	Quantity	Packaging Option	Packaging Specification
Pxxx0TB	DO-214AC	5000	Tape & Reel -12mm/13'tape	EIA -481